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Attorney's Docket No. 5649-968

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re: Lee et al.

Serial No.: 10/046,805

Filed: January 14, 2002

For: METHODS OF FORMING METAL LAYERS IN INTEGRATED CIRCUIT  
DEVICES USING SELECTIVE ELECTROPLATING ON EDGES OF RECESSES  
AND CONDUCTIVE CONTACTS SO FORMED

Group Art Unit:

Examiner: To Be Assigned

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Date: February 18, 2002

Commissioner for Patents  
Washington, DC 20231  
Attn: Drawing Review Branch

**SUBMITTAL OF FORMAL DRAWINGS**

Sir:

Enclosed herewith is one set (11 sheets) of new formal drawings. It is requested that these new drawings be substituted for the originally filed informal drawings.

Respectfully submitted,

Robert N. Crouse  
Registration No. 44,635



20792

PATENT TRADEMARK OFFICE

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**CERTIFICATE OF MAILING**

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, Washington, DC 20231, Attn: Drawing Review Branch, on February 18, 2002.

Candi L. Riggs

Date of Signature: February 18, 2002